

**Am29841A/Am29843A/Am29845A
Am29941A/Am29943A/Am29945A**

High-Performance Bus Interface Latches

DISTINCTIVE CHARACTERISTICS

- High-speed parallel latches
 - transparent $t_{PD} = 5.0$ ns typical
 - Buffered common latch enable, clear and preset input
 - Three-state outputs glitch-free during power-up and down. Outputs have Schottky clamp to ground
 - I_{OL} : 48 mA Commercial, 32 mA Military
 - Higher speed, lower power versions of the Am29841, Am29843, and Am29845
 - Am29900A DIP pinout option reduces lead inductance on V_{CC} and GND pins

GENERAL DESCRIPTION

The Am29841A, Am29843A, and Am29845A Buffered Latches are designed to eliminate the extra devices required to buffer stand alone latches and to provide extra data width for wider address/data paths or buses carrying parity. The Am29800A latches are produced with AMD's exclusive IMOX® bipolar process, and feature typical propagation delays of 5 ns, as well as high-capacitive drive capability.

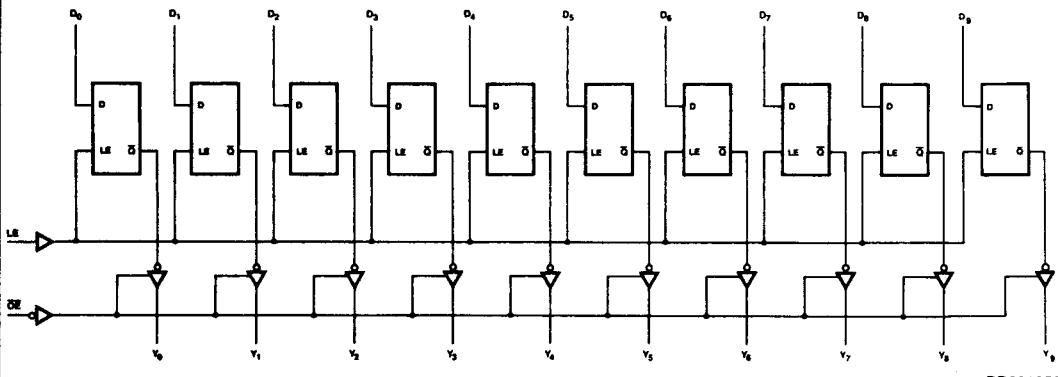
The Am29841A is a buffered, 10-bit version of the popular '373 function. The Am29843A is a 9-bit wide buffered latch with Preset (PRE) and Clear (CLR) — ideal for parity bus interfacing in high-performance microprogrammed sys-

tems. The Am29845A, an 8-bit buffered latch, has all the 9-bit controls, plus multiple enables (\overline{OE}_1 , \overline{OE}_2 , \overline{OE}_3), to allow multi-user control of the interface; e.g., CS, DMA, and RD/WR. The device is ideal for use as an output port requiring high $|\overline{IO}_1|$ / $|\overline{IO}_2|$.

The Am29800A latches are available in the standard package options: DIPs, PLCCs, LCCs, SOICs, and Flatpacks. In addition, a DIP pinout option, featuring center V_{CC} and GND pins, reduces the lead inductance of the V_{CC} and GND pins. The ordering part numbers for latches with this pinout are the Am29941A, Am29943A, and Am29945A; their pinouts are shown later in this data sheet.

BLOCK DIAGRAMS**

Am29841A



BD001056

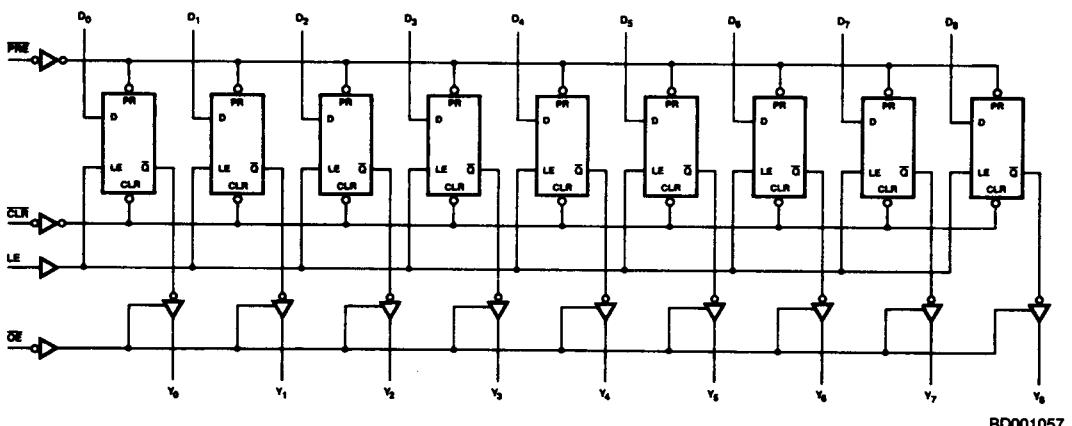
*IMOX is a trademark of Advanced Micro Devices, Inc.

****See following pages for additional Block Diagrams.**

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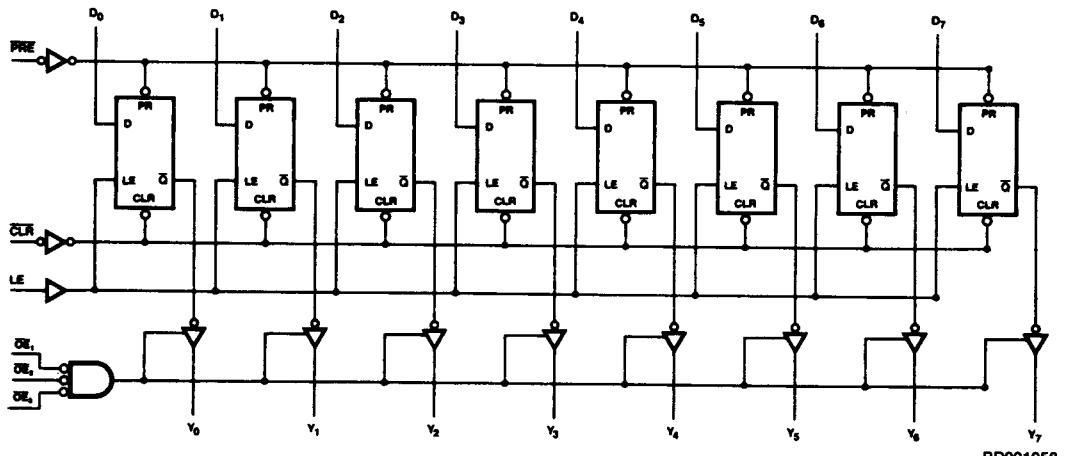
BLOCK DIAGRAMS (Cont'd.)

Am29843A



BD001057

Am29845A



BD001058

CONNECTION DIAGRAMS
Top View

Am29841A/Am29843A/Am29845A
Am29941A/Am29943A/Am29945A

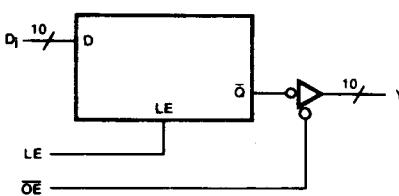
<p align="center">Am29841A</p> <p>DIPs*</p> <p>CD001380</p>	<p align="center">LCC**</p> <p>CD001390</p>	<p align="center">Am29941A</p> <p>DIPs</p> <p>CD010722</p>
<p align="center">Am29843A</p> <p>DIPs*</p> <p>CD001400</p>	<p align="center">LCC**</p> <p>CD001410</p>	<p align="center">Am29943A</p> <p>DIPs</p> <p>CD010723</p>
<p align="center">Am29845A</p> <p>DIPs*</p> <p>CD001340</p>	<p align="center">LCC**</p> <p>CD001350</p>	<p align="center">Am29945A</p> <p>DIPs</p> <p>CD010724</p>

*Also available in 24-Pin Flatpack and Small Outline packages; pinout identical to DIPs.

**Also available in 28-Pin PLCC; pinout identical to LCC.

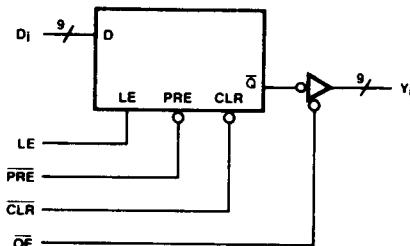
LOGIC SYMBOLS

Am29841A



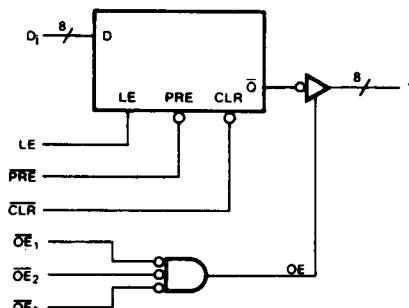
LS000463

Am29843A



LS000473

Am2985A



LS000443

FUNCTION TABLES

Am29841A

Inputs			Internal	Outputs	Function
\bar{OE}	LE	D_I	\bar{Q}_I	Y_I	
H	X	X	X	Z	Hi-Z
H	H	L	H	Z	Hi-Z
H	H	H	L	Z	Hi-Z
H	L	X	NC	Z	Latched (Hi-Z)
L	H	L	H	L	Transparent
L	H	H	L	H	Transparent
L	L	X	NC	NC	Latched

H = HIGH

NC = No Change

L = LOW

Z = High Impedance

X = Don't Care

FUNCTION TABLES (Cont'd.)

Am29843A

Inputs					Internal	Outputs	Function
CLR	PRE	OE	LE	D _I	Q̄ _I	Y _I	
H	H	H	X	X	X	Z	Hi-Z
H	H	H	H	L	H	Z	Hi-Z
H	H	H	H	H	L	Z	Hi-Z
H	H	H	L	X	NC	Z	Latched (Hi-Z)
H	H	L	H	L	H	L	Transparent
H	H	L	H	H	L	H	Transparent
H	H	L	L	X	NC	NC	Latched
H	L	L	X	X	L	H	Preset
L	H	L	X	X	H	L	Clear
L	L	L	X	X	L	H	Preset
L	H	H	L	X	H	Z	Latched (Hi-Z)
H	L	H	L	X	L	Z	Latched (Hi-Z)

Am29845A

OE*	Inputs					Internal	Outputs	Function
	CLR	PRE	LE	D _I	Q̄ _I	Y _I		
L	H	H	X	X	X	Z	Hi-Z	
L	H	H	H	L	H	Z	Hi-Z	
L	H	H	H	H	L	Z	Hi-Z	
L	H	H	L	X	NC	Z	Latched (Hi-Z)	
H	H	H	H	L	H	L	Transparent	
H	H	H	H	H	L	H	Transparent	
H	H	H	L	X	NC	NC	Latched	
H	H	L	X	X	L	H	Preset	
H	L	H	X	X	H	L	Clear	
H	L	L	X	X	L	H	Preset	
L	L	H	L	X	H	Z	Latched (Hi-Z)	
L	H	L	L	X	L	Z	Latched (Hi-Z)	

*OE is an Active HIGH internal signal produced as follows:

OE ₁	OE ₂	OE ₃	OE
H	X	X	L
X	H	X	L
X	X	H	L
L	L	L	H

H = HIGH
L = LOW
NC = No Change
Z = High Impedance
X = Don't Care

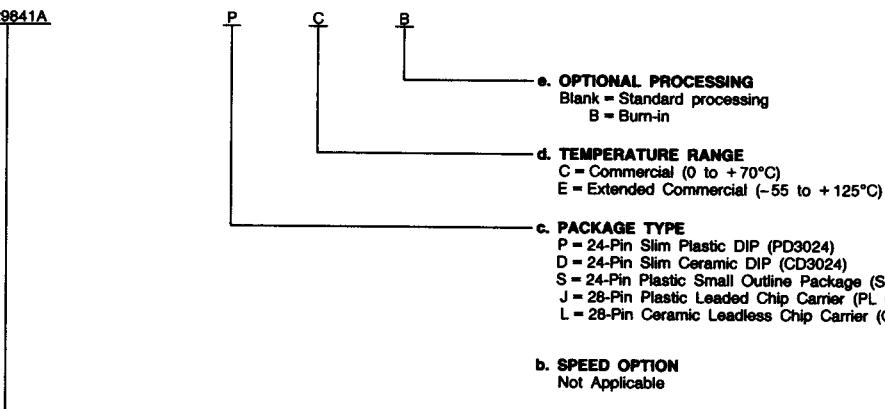
ORDERING INFORMATION

Standard Products

AMD products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of:

- a. Device Number
- b. Speed Option (if applicable)
- c. Package Type
- d. Temperature Range
- e. Optional Processing

AM29841A

**e. OPTIONAL PROCESSING**

Blank = Standard processing
B = Burn-in

d. TEMPERATURE RANGE

C = Commercial (0 to +70°C)
E = Extended Commercial (-55 to +125°C)

c. PACKAGE TYPE

P = 24-Pin Slim Plastic DIP (PD3024)
D = 24-Pin Slim Ceramic DIP (CD3024)
S = 24-Pin Plastic Small Outline Package (SO 024)
J = 28-Pin Plastic Leaded Chip Carrier (PL 028)
L = 28-Pin Ceramic Leadless Chip Carrier (CL 028)

b. SPEED OPTION

Not Applicable

a. DEVICE NUMBER/DESCRIPTION

Am29841A	10-Bit Latch
Am29843A	9-Bit Latch
Am29845A	8-Bit Latch
Am29941A	10-Bit Latch (Center-V _{CC} -and-GND Pinout)
Am29943A	9-Bit Latch (Center-V _{CC} -and-GND Pinout)
Am29945A	8-Bit Latch (Center-V _{CC} -and-GND Pinout)

Valid Combinations	
AM29841A	PC, PCB, DC, DCB, DE, SC, JC, LC
AM29843A	
AM29845A	
AM29941A	PC, PCB, DC, DCB, DE
AM29943A	
AM29945A	

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, to check on newly released valid combinations, and to obtain additional data on AMD's standard military grade products.

ORDERING INFORMATION (Cont'd.)

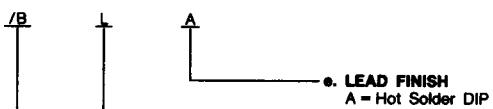
APL Products

Am29841A/Am29843A/Am29845A
Am29941A/Am29943A/Am29945A

AMD products for Aerospace and Defense applications are available in several packages and operating ranges. APL (Approved Products List) products are fully compliant with MIL-STD-883C requirements. The order number (Valid Combination) for APL products is formed by a combination of:

- a. Device Number
- b. Speed Option (if applicable)
- c. Device Class
- d. Package Type
- e. Lead Finish

AM29841A



- d. PACKAGE TYPE
L = 24-Pin Slim Ceramic DIP (CD3024)
K = 24-Pin Rectangular Medium Ceramic Flatpack (CFM024)
3 = 28-Pin Ceramic Leadless Chip Carrier (CL 028)

- c. DEVICE CLASS
/B = Class B

- b. SPEED OPTION
Not Applicable

a. DEVICE NUMBER/DESCRIPTION

- Am29841A 10-Bit Latch
- Am29843A 9-Bit Latch
- Am29845A 8-Bit Latch
- Am29941A 10-Bit Latch (Center-Vcc-and-GND Pinout)
- Am29943A 9-Bit Latch (Center-Vcc-and-GND Pinout)
- Am29945A 8-Bit Latch (Center-Vcc-and-GND Pinout)

Valid Combinations	
AM29841A	/BLA, /BKA, /B3A
AM29843A	
AM29845A	
AM29941A	
AM29943A	/BLA
AM29945A	

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations or to check for newly released valid combinations.

Group A Tests

Group A tests consist of Subgroups
1, 2, 3, 7, 8, 9, 10, 11.

PIN DESCRIPTION**D_i Data Inputs (Input)**

D_i are the latch data inputs.

Y_i Data Outputs (Output)

Y_i are the three-state data outputs.

LE Latch Enable (Input, Active HIGH)

The latches are transparent when LE is HIGH. Input data is latched on a HIGH-to-LOW transition.

Am29841A**OE Output Enable (Input, Active LOW)**

When OE is LOW, the latch data is passed to the Y_i outputs.

When OE is HIGH, the Y_i outputs are in the high-impedance state.

Am29843A**OE Output Enable (Input, Active LOW)**

When OE is LOW, the latch data is passed to the Y_i outputs.

When OE is HIGH, the Y_i outputs are in the high-impedance state.

PRE Preset (Input, Active LOW)

When PRE is LOW, the outputs are HIGH if OE is LOW. PRE overrides the CLR pin. PRE will set the latch independent of the state of OE.

CLR Clear (Input, Active LOW)

When CLR is LOW, the internal latch is cleared. When CLR is LOW, the outputs are LOW if OE is LOW and PRE is HIGH. When CLR is HIGH, data can be entered into the latch.

Am29845A**OE_i Output Enables (Input, Active LOW)**

When OE₁, OE₂, and OE₃ are all LOW, the latch data is passed to the Y_i outputs. If any or all OE_i are HIGH, the Y_i outputs are put in a high impedance state.

PRE Preset (Input, Active LOW)

When PRE is LOW, the outputs are HIGH if all OE_i are LOW. PRE overrides the CLR pin. PRE will set the latch independent of the state of OE.

CLR Clear (Input, Active LOW)

When CLR is LOW, the internal latch is cleared. When CLR is LOW, the Y_i outputs are LOW if all OE_i are LOW and PRE is HIGH. When CLR is HIGH, data can be entered into the latch.

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-65 to +150°C
Ambient Temperature with Power Applied	-55 to +125°C
Supply Voltage to Ground Potential Continuous	-0.5 V to +7.0 V
DC Voltage Applied to Outputs for High Output State	-0.5 V to +5.5 V
DC Input Voltage	-1.5 V to +6.0 V
DC Output Current, into Outputs	100 mA
DC Input Current	-30 mA to +5.0 mA

Stresses above those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

OPERATING RANGES

Commercial (C) Devices	
Temperature (T_A)	0 to +70°C
Supply Voltage (V_{CC})	+4.5 V to +5.5 V
Military (M) and Extended Commercial (E) Devices	
Temperature (T_C)	-55 to +125°C
Supply Voltage (V_{CC})	+4.5 V to +5.5 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

DC CHARACTERISTICS over operating range unless otherwise specified (for APL Products, Group A, Subgroups 1, 2, 3 are tested unless otherwise noted)

Parameter Symbol	Parameter Description	Test Conditions		Min.	Max.	Units
V_{OH}	Output HIGH Voltage	$V_{CC} = 4.5\text{ V}$ $V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -15\text{ mA}$	2.4		Volts
			$I_{OH} = -24\text{ mA}$	2.0		
V_{OL}	Output LOW Voltage	$V_{CC} = 4.5\text{ V}$ $V_{IN} = V_{IH}$ or V_{IL}	MIL, $I_{OL} = 32\text{ mA}$		0.5	Volts
			COM'L, $I_{OL} = 48\text{ mA}$		0.5	
V_{IH}	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for All Inputs (Note 1)		2.0		Volts
V_{IL}	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for All Inputs (Note 1)			0.8	Volts
V_I	Input Clamp Voltage	$V_{CC} = 5.5\text{ V}$, $I_{IN} = -18\text{ mA}$			-1.2	Volts
I_{IL}	Input LOW Current	$V_{CC} = 5.5\text{ V}$, $V_{IN} = 0.4\text{ V}$			-0.5	mA
I_{IH}	Input HIGH Current	$V_{CC} = 5.5\text{ V}$, $V_{IN} = 2.7\text{ V}$			50	μA
I_I	Input HIGH Current	$V_{CC} = 5.5\text{ V}$, $V_{IN} = 5.5\text{ V}$			100	μA
I_{OZL}	Output Off-State Current (High Impedance)	$V_{CC} = 5.5\text{ V}$	$V_O = 0.4\text{ V}$		-50	μA
			$V_O = 2.7\text{ V}$		50	
I_{SC}	Output Short-Circuit Current	$V_{CC} = 5.5\text{ V}$, $V_{OUT} = 0\text{ V}$ (Note 2)		-75	-250	mA
I_{OFF}	Bus Leakage Current	$V_{CC} = 0\text{ V}$, $V_{OUT} = 2.9\text{ V}$			100	μA
I_{CC}	Supply Current	$V_{CC} = 5.5\text{ V}$ Outputs Unloaded	Outputs LOW		97	mA
			Outputs HIGH		70	
			Outputs Hi-Z		81	

- Notes:** 1. Input thresholds are tested during DC parameter testing, and may be tested in combination with other DC parameters.
 2. Not more than one output shorted at a time. Duration of the short-circuit test should not exceed one second.

SWITCHING CHARACTERISTICS over operating range unless otherwise specified (for APL Products,
Group A, Subgroups 9, 10, 11 are tested unless otherwise noted)

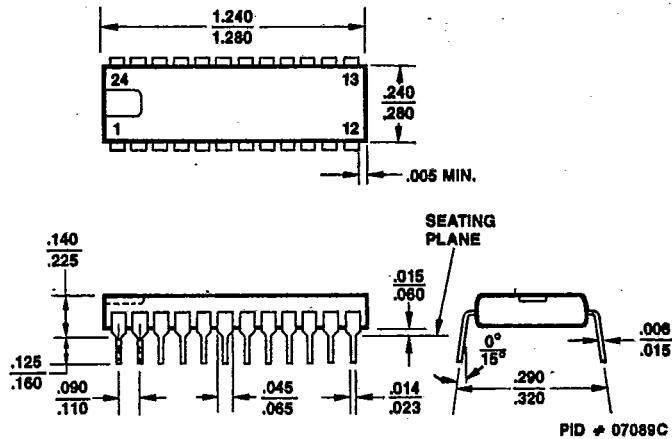
Parameter Symbol	Parameter Description	Test Conditions*	COMMERCIAL		MILITARY		Units
			Min.	Max.	Min.	Max.	
t_{PLH}	Data (D_i) to Output Y_i (LE = HIGH)	$C_L = 50 \text{ pF}$ $R_1 = 500 \Omega$ $R_2 = 500 \Omega$		7		8.5	ns
t_{PHL}				9		10	ns
t_S	Data to LE Setup Time		2.5		3.5		ns
t_H	Data to LE Hold Time		2.5		3.5		ns
t_{PLH}	Latch Enable (LE) to Y_i			12		13	ns
t_{PHL}				12		13	ns
t_{PLH}	Propagation Delay, Preset to Y_i			12		14	ns
t_{PHL}				12		14	ns
t_{REC}	Preset (PRE $\overline{\sqcap}$) to LE Setup Time		4		5		ns
t_{PLH}	Propagation Delay, Clear to Y_i			13		14	ns
t_{PHL}				13		14	ns
t_{REC}	Clear (CLR $\overline{\sqcap}$) to LE Setup Time		7		8		ns
$t_{PW\text{H}}$	LE Pulse Width	HIGH	4		5		ns
$t_{PW\text{L}}$	Preset Pulse Width	LOW	5		7		ns
$t_{PW\text{L}}$	Clear Pulse Width	LOW	4		5		ns
t_{ZH}	Output Enable Time $\overline{OE} \overline{\sqcap}$ to Y_i			10.5		13.5	ns
t_{ZL}				11.5		14.5	ns
t_{HZ}	Output Disable Time $\overline{OE} \overline{\sqcap}$ to Y_i			8		10	ns
t_{LZ}				8		10	ns

*See Test Circuit and Waveforms.

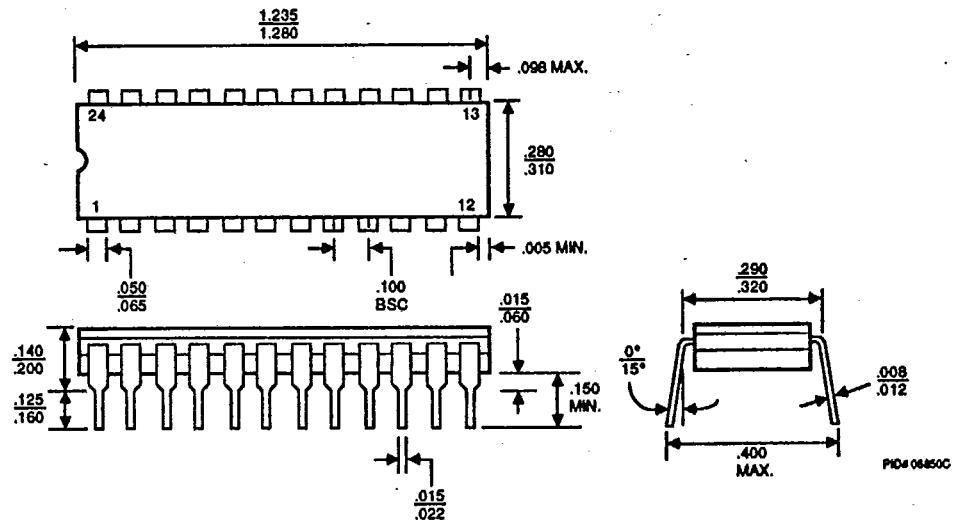
PACKAGE OUTLINES*

T-90-20

PD3024



CD3024

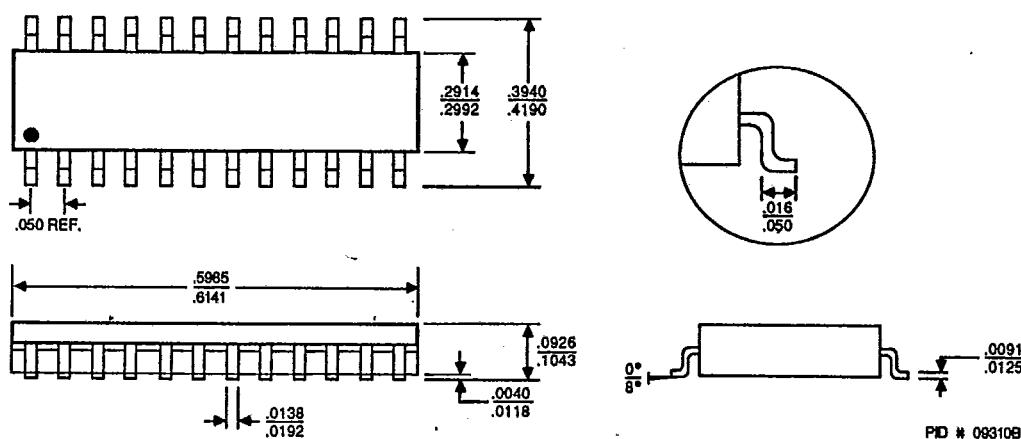


*For reference only.

PACKAGE OUTLINES (Cont'd.)

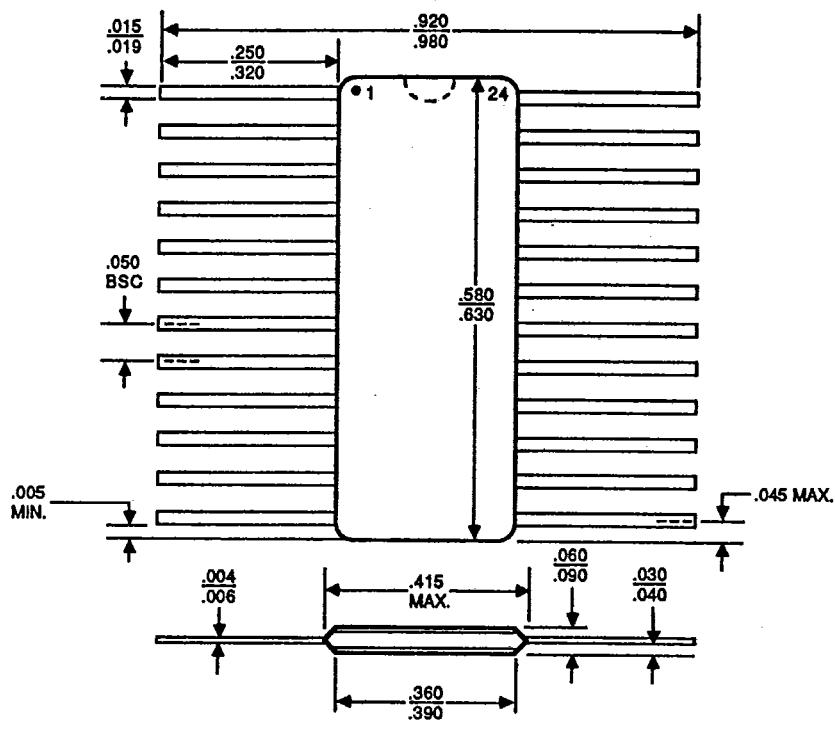
T-90-20

SO 024



PID # 093108

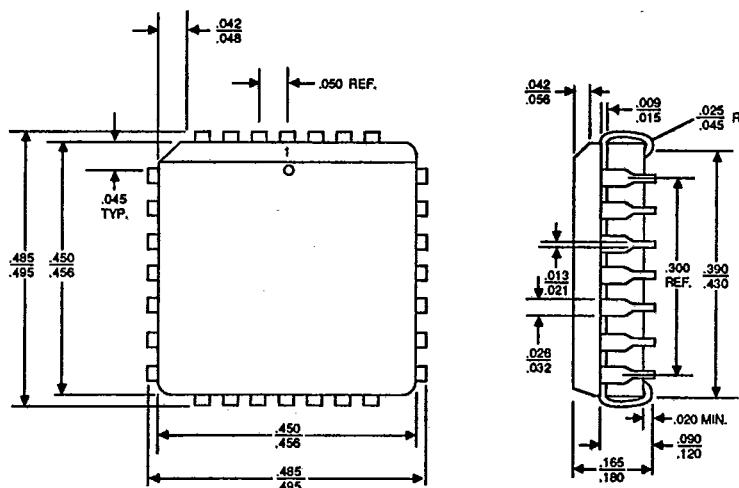
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PID # 07371C

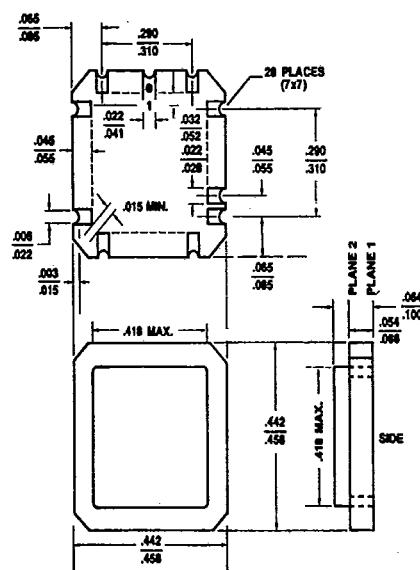
T-90-20

PL 028



P1D #06751E

CL 028



P10 # 085950

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